

16-bit Constant Current LED Sink Driver with Gain Control

Features

- 16 constant-current output channels
- Output current adjustable through an external resistor
- Programmable output current gain for White Balance
- Constant output current range: 5-90 mA
- Excellent output current accuracy:
 between channels: ±3% (max.), and
 between ICs: ±6% (max.)
- Constant output current invariant to load voltage change
- Fast response of output current, \overline{OE} (min.): 200 ns
- 25MHz clock frequency
- Schmitt trigger input
- 5V supply voltage

MBI5028CN\CNS
PRIVATE
CN: P-DIP24-300-2.54
CNS: SP-DIP24-300-1.78
MBI5028CD\CF
CD: SOP24-300-1.27
CF: SOP24-300-1.00
MBI5028CP\CPA
CP\CPA: SSOP24-150-0.64

Current A	Conditions			
Between Channels	Between ICs	Conditions		
< ±3%	< ±6%	I _{OUT} = 10 ~ 60 mA		

MBI5028 16-bit Constant Current LED Sink Driver with Gain Control

Product Description

MBI5028 succeeds MBI5026 and is designed for LED displays with Gain Control extension. MBI5028 exploits PrecisionDrive™ technology to enhance its output characteristics. MBI5028 contains a 16-bit shift register and data latches, which convert serial input data into parallel output format. At MBI5028 output stage, sixteen regulated current ports are designed to provide constant current sinks for driving LEDs within a wide range of Vf variations.

MBI5028 provides users with great flexibility and device performance while using MBI5028 in their LED panel system design. Users may adjust the output current from 5 mA to 90 mA through an external resistor R_{ext} , which gives users flexibility in controlling the light intensity of LEDs. MBI5028 guarantees to endure maximum 17V at the output port. The high clock frequency, 25 MHz, also satisfies the system requirements of high volume data transmission.

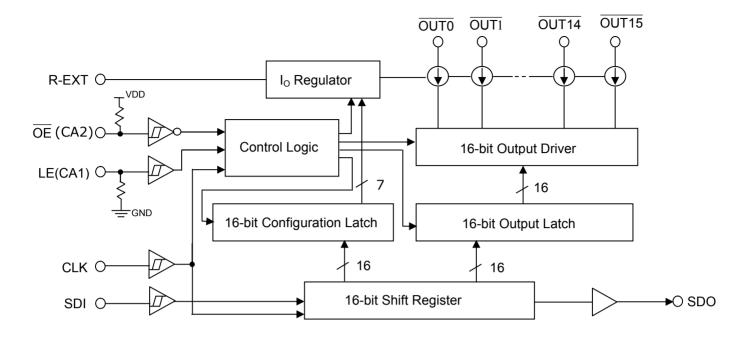
MBI5028 also exploits Share-I-O™ technology and is backward compatible with MBI5026 in both electrical characteristics and package aspect. To utilize the Current Adjust feature, users may not have to change the printed circuit board originally for MBI5026. To enter a special function mode--Current Adjust mode, users just need to set a specific sequence of signals on LE(CA1), \overline{OE} (CA2) and CLK input pins. Normally, the output current can be regulated only through an external resistor. In addition, in the Current Adjust mode, the output current can be software-programmable by a system controller. The system controller adjusts the output current by sending a 7-bit Current Adjust code to 16-bit Configuration Latch through MBI5028 SDI pin. The code will be latched and effective to control the output current regulator. A fine adjustment of the output current could be achieved by a gain ranging from 0.5 to 1.984 with 128 fine steps. By setting another sequence of signals on LE(CA1), \overline{OE} (CA2) and CLK input pins, MBI5028 may resume to a Normal mode and perform as MBI5026. The Shift Register, with SDI, SDO, and CLK, carries the image data as usual.

By means of the Share-I-O™ technique, an additionally effective function, Current Gain, can be added to LED drivers, MBI5028, without any extra pins. Thus, MBI5028 could be a drop-in replacement of MBI5026. The printed circuit board originally designed for MBI5026 may be also applicable for MBI5028.

For MBI5028, Pin LE and OE can respectively offer two functions:

Device Type	Pin Name	Function description	
CN\CNS\CD\CF\CP Pin4		LE+Current Adjust	
CPA	Pin10	LE+Current Adjust	
CN\CNS\CD\CF\CP Pin21		OE +Current Adjust	
CPA	Pin3	OE +Current Adjust	

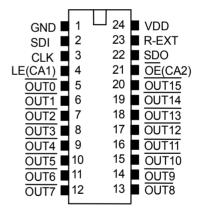
Block Diagram



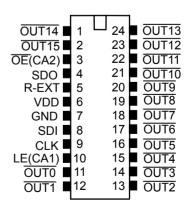
Terminal Description

Pin Name	Function
GND	Ground terminal for control logic and current sink
SDI	Serial-data input to the Shift Register
CLK	Clock input terminal for data shift on rising edge
	Data strobe input terminal
LE(CA1)	Serial data is transferred to the respective latch when LE(CA1) is high. The data is latched when LE(CA1) goes low.
	Also, a control signal input for Current Adjust mode (See Timing Diagram)
OUT0 ~ OUT15	Constant current output terminals
	Output enable terminal
	When \overline{OE} (CA2)(active) low, the output drivers
OE (CA2)	are enabled; when $\overline{\sf OE}$ (CA2) high, all output drivers are turned OFF (blanked).
	Also, a second control signal input for Current Adjust mode (See Timing Diagram)
SDO	Serial-data output to the following SDI of next driver IC
R-EXT	Input terminal used to connect an external resister for setting up all output current
VDD	5V supply voltage terminal

Pin Configuration



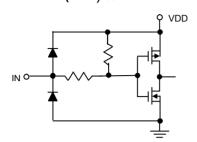
MBI5028CN\CNS\CD\CF\CP



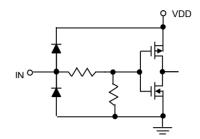
MBI5028CPA

Equivalent Circuits of Inputs and Outputs

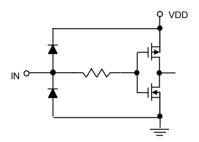
OE (CA2) terminal



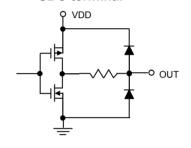
LE(CA1) terminal



CLK, SDI terminal

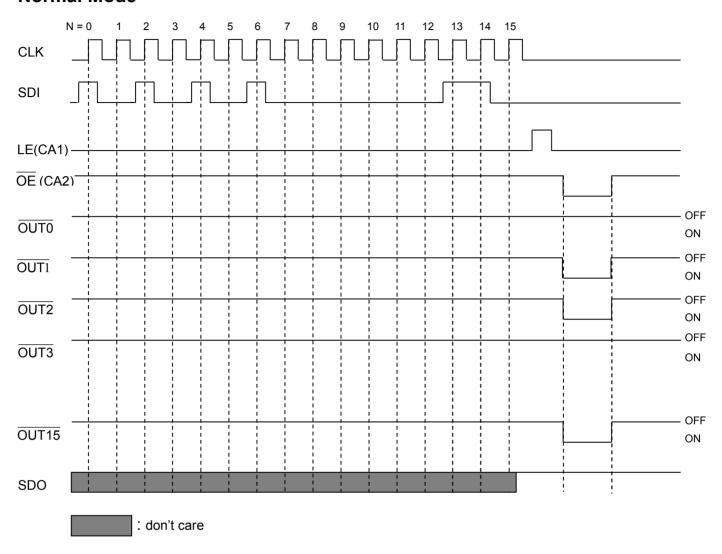


SDO terminal



Timing Diagram

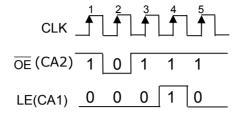
Normal Mode



Truth Table (In Normal Mode)

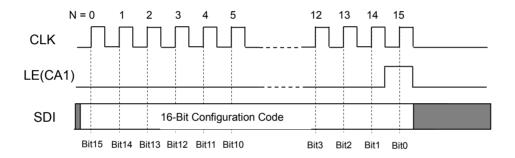
CLK	LE	ŌĒ	SDI	OUT0 OUT7 OUT15	SDO
	Н	L	D _n	Dn Dn - 7 Dn - 15	D _{n-15}
	L	L	D _{n+1}	No Change	D _{n-14}
	Н	L	D _{n+2}	\overline{D} n + 2 \overline{D} n - 5 \overline{D} n - 13	D _{n-13}
—	Х	L	D _{n+3}	<u>Dn+2</u> <u>Dn-5</u> <u>Dn-13</u>	D _{n-13}
	Х	Н	D _{n+3}	Off	D _{n-13}

Switching to Current Adjust Mode



The signal sequence makes MBI5028 enter a Current Adjust mode. Here, the LE active pulse would not latch any data.

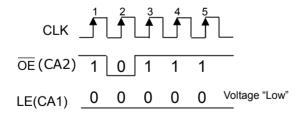
Writing Configuration Code



Note:

In the Current Adjust mode, by sending the positive pulse of LE(CA1), the content of the Shift Register, a Current Adjust code, will be written to the 16-Bit Configuration Latch.

Switching to Normal Mode



The signal sequence makes MBI5028 resume to a Normal mode.

Note:

Pin OE (CA2) could always enable the output port no matter MBI5028 enters a Current Adjust mode or not. If users want to know the whole process, that is how to enter a Current Adjust mode, write Current Adjust codes and resume to a Normal mode, please refer to the contents in **Application Information**.

MBI5028 16-bit Constant Current LED Sink Driver with Gain Control

Maximum Ratings

Charact	eristic	Symbol	Rating	Unit
Supply Voltage		V_{DD}	0 ~ 7.0	V
Input Voltage		V _{IN}	-0.4 ~ V _{DD} +0.4	V
Output Current		I _{OUT}	+90	mA
Output Voltage		V_{DS}	-0.5 ~ +20.0	V
Clock Frequency		F _{CLK}	25	MHz
GND Terminal Current		I _{GND}	1440	mA
	CN – type		2.32	
	CNS – type		1.87	
Power Dissipation	CD – type		2.51	107
(On PCB, Ta=25°C)	CF – type	- P _D	2.12	W
	CP – type		1.73	
	CPA – type		1.73	
	CN – type		53.82	
	CNS – type		66.74	
Thermal Resistance	CD- type	49.81		°C/W
(On PCB, Ta=25°C)	CF – type	$ R_{th(j-a)}$	59.01	C/VV
	CP – type		72.43	
	CPA – type		72.43	
Operating Temperature		T _{opr}	-40~+85	°C
Storage Temperature		T _{stg}	-55~+150	°C

MBI5028 16-bit Constant Current LED Sink Driver with Gain Control

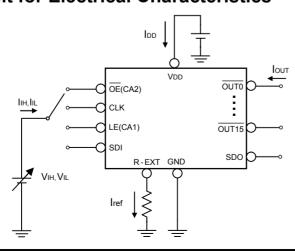
Recommended Operating Conditions

Characteristic	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply Voltage	V_{DD}	-	4.5	5.0	5.5	V
Output Voltage	V _{DS}	OUT0∼OUT15	-	-	17.0	V
	I _{OUT}	DC Test Circuit	5	-	90	mA
Output Current	I _{OH}	SDO	-	-	-1.0	mA
	I _{OL}	SDO	-	-	1.0	mA
Input Voltage	V _{IH}	CLK, OE (CA2), LE(CA1) and SDI	0.8V _{DD}	-	V _{DD} +0.3	V
input voitage	V _{IL}	CLK, OE (CA2), LE(CA1) and SDI	-0.3	-	0.3V _{DD}	V
LE(CA1) Pulse Width	$t_{w(L)}$		40	-	-	ns
OE (CA2) Pulse Width	t _{w(OE)}		200	-	-	ns
CLK Pulse Width	t _{w(CLK)}		20	-	-	ns
Setup Time for SDI	t _{su(D)}	│Normal Mode _V _{DD} =4.5~5.5V	5	-	-	ns
Hold Time for SDI	t _{h(D)}		10	-	-	ns
Setup Time for LE(CA1)	t _{su(L)}		15	-	-	ns
Hold Time for LE(CA1)	t _{h(L)}		15	-	-	ns
CLK Pulse Width	t _{w(CLK)}		20	-	-	ns
Setup Time for LE(CA1)			5	-	-	ns
Hold Time for LE(CA1)	t _{h(CA1)}	Current Adjust Mode _V _{DD} =4.5~5.5V	10	-	-	ns
Setup Time for OE (CA2)	t _{su(CA2)}	7.00 3.3.	5	-	-	ns
Hold Time for OE (CA2)	t _{h(CA2)}		10	-	-	ns
Clock Frequency	F _{CLK}	Cascade Operation	-	-	25.0	MHz

Electrical Characteristics

Characteristic		Symbol	Cond	lition	Min.	Тур.	Max.	Unit
Supply Voltag	е	V_{DD}	-	4.5	5.0	5.5	V	
Output Voltage	е	V _{DS}	OUT0~OUT15		-	-	17.0	V
		I _{OUT}	DC Test Circuit		5	-	90	mA
Output Curren	t	I _{OH}	SDO		-	-	-1.0	mA
		I _{OL}	SDO		-	-	1.0	mA
Innut Voltage	"H" level	V _{IH}	Ta = -40~85°C		0.8V _{DD}	-	V_{DD}	V
Input Voltage	"L" level	V _{IL}	Ta = -40~85°C		GND	-	$0.3V_{DD}$	V
Output Leaka	ge Current	I _{OH}	V _{OH} =17.0V		_	-	0.5	μΑ
Output	000	V _{OL}	I _{OL} =+1.0mA		-	-	0.4	V
Voltage	SDO	V _{OH}	I _{OH} =-1.0mA		4.6	-	-	V
Output Curren	t 1	I _{OUT1}	V _{DS} =0.6V	R _{ext} =720 Ω	-	26.0	-	mA
Current Skew	Current Skew dI_{OUT1} I_{OL} =26mA V_{DS} =0.6V R_{ext} =720 Ω		R _{ext} =720 Ω	-	±1	±3	%	
Output Curren	t 2	I _{OUT2}	V _{DS} =0.8V	R _{ext} =360 Ω	-	52.1	-	mA
Current Skew		dl _{OUT2}	I _{OL} =52.1mA V _{DS} =0.8V		-	±1	±3	%
	utput Current vs. utput Voltage Regulation %/dV _{DS}		V _{DS} within 1.0V ar	nd 3.0V	-	±0.1	-	% / V
Output Curren Supply Voltage		%/dV _{DD}	V _{DD} within 4.5V ar	nd 5.5V	-	±1	-	% / V
Pull-up Resist	er	R _{IN} (up)	OE (CA2)		250	500	800	ΚΩ
Pull-down Res	sister	R _{IN} (down)	LE(CA1)		250	500	800	ΚΩ
		I _{DD} (off) 1	R _{ext} =Open, OUT	0 ~ OUT15 =Off	-	7	12	
	"OFF"	I _{DD} (off) 2	R_{ext} =720 Ω , $\overline{\text{OUT0}} \sim \overline{\text{OUT15}}$ =Off		-	10	12	
Supply Current		I _{DD} (off) 3	R _{ext} =360 Ω, OUT	-	12	15	mA	
	"ON"	I _{DD} (on) 1	R _{ext} =720 Ω, OUT	0~OUT15 =On	-	10	18	
	ON	I _{DD} (on) 2	R _{ext} =360 Ω, OUT	0 ~ OUT15 =On	-	12	20	

Test Circuit for Electrical Characteristics

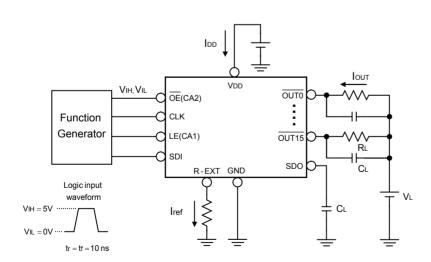


Switching Characteristics

Character	Symbol	Condition	Min.	Тур.	Max.	Unit	
	CLK - OUTn	t _{pLH1}		-	50	100	ns
Propagation Delay Time	LE(CA1) - OUTn	t _{pLH2}		-	50	100	ns
("L" to "H")	OE (CA2)- OUTn	t _{pLH3}		-	20	100	ns
	CLK - SDO	t _{pLH}		15	20	-	ns
	CLK - OUTn	t _{pHL1}	V_{DD} =5.0 V V_{DS} =0.8 V	-	100	150	ns
Propagation Delay Time	LE(CA1) - OUTn	t _{pHL2}	$V_{IH}=V_{DD}$	-	100	150	ns
("H" to "L")	OE (CA2)- OUTn	t _{pHL3}	V_{IL} =GND R_{ext} =300 $Ω$	-	50	150	ns
	CLK - SDO	t _{pHL}	V _L =4.0 V	15	20	-	ns
	CLK	t _{w(CLK)}	R_L =52 Ω C_L =10 pF	20	-	-	ns
Pulse Width	LE(CA1)	t _{w(L)}	- L	20	-	-	ns
	OE (CA2)	t _{w(OE)}		200	-	-	ns
Hold Time for LE(CA1)		t _{h(L)}		5	-	-	ns
Setup Time for LE(CA1)	t _{su(L)}		5	-	-	ns	
Maximum CLK Rise Time		t _r **		-	-	500	ns
Maximum CLK Fall Time	t _f **		-	-	500	ns	
Output Rise Time of Vout	t _{or}		-	40	120	ns	
Output Fall Time of Vout (t	turn on)	t _{of}		-	70	200	ns

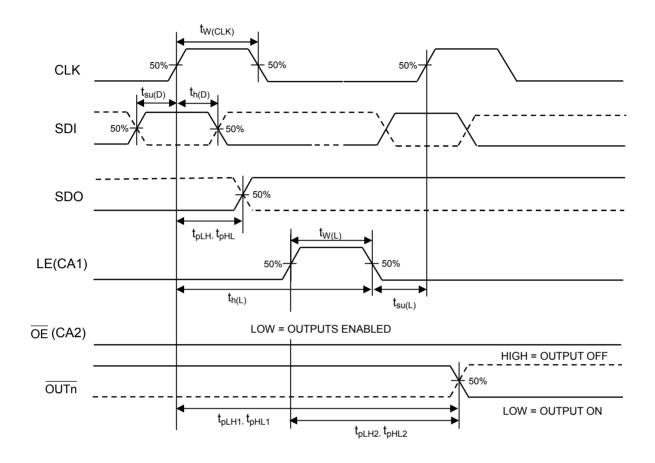
^{**}If the devices are connected in cascade and t_r or t_f is large, it may be critical to achieve the timing required for data transfer between two cascaded devices.

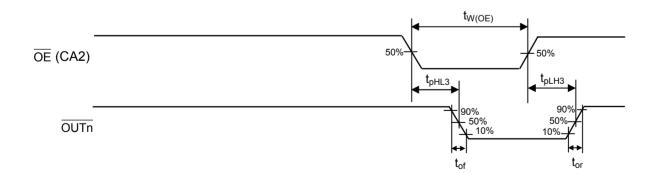
Test Circuit for Switching Characteristics



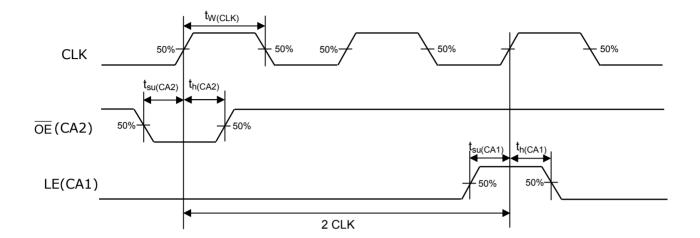
Timing Waveform

Normal Mode





Switching to Current Adjust Mode

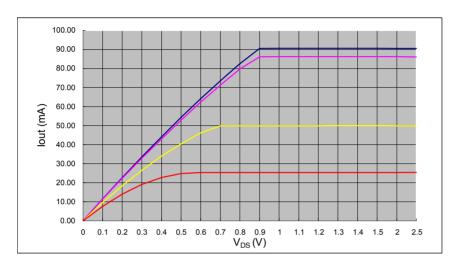


Application Information

Constant Current

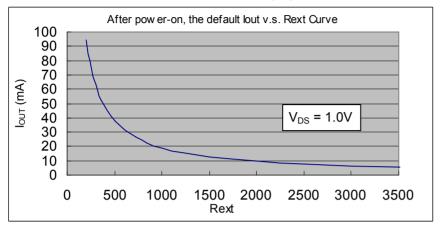
In LED display applications, MBI5028 provides nearly no variations in current from channel to channel and from IC to IC. This can be achieved by:

- 1) The maximum current variation between channels is less than $\pm 3\%$, and that between ICs is less than $\pm 6\%$.
- 2) In addition, the current characteristic of output stage is flat and users can refer to the figure as shown below. The output current can be kept constant regardless of the variations of LED forward voltages (Vf). This performs as a perfection of load regulation.



Adjusting Output Current

The output current of each channel (I_{OUT}) is set by an external resistor, R_{ext} . After power-on, the default relationship between I_{out} and R_{ext} is shown in the following figure.



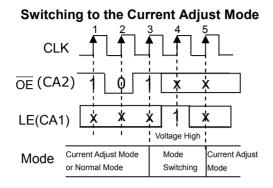
Resistance of the external resistor, R_{ext} , in Ω

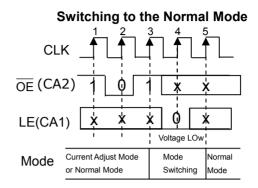
Also, the output current can be calculated from the equations:

$$V_{R-EXT} = 0.63Volt \times G$$
; $I_{OUT} = (V_{R-EXT} / R_{ext}) \times 15$

where R_{ext} , is the resistance of the external resistor connected to R-EXT terminal and V_{R-EXT} is the voltage of R-EXT terminal. Conceptually, G is the digital current gain, defined by the Current Adjust Code. After power-on, the default value of G is 1.984. Based on the default gain, $I_{OUT} = (0.63 \text{Volt x } 1.984 \text{ / } R_{ext}) \times 15 = (1.25 \text{Volt/ } R_{ext}) \times 15$, if another end of the resistor R_{ext} is connected to the ground. The magnitude of current is around 52.1mA at 360 Ω and 26.0mA at 720 Ω . The section "16-bit Configuration Code" would describe how to set up the gain, G.

Operation Mode Switching



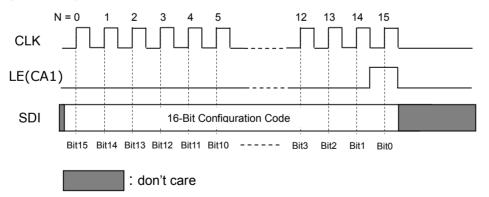


As shown in the above figures, once a short pulse "101" of \overline{OE} (CA2) appears, MBI5028 would go through the mode switching. At the fourth rising edge of CLK, if LE(CA1) is sampled as "Voltage High", MBI5028 would switch to the Current Adjust mode; otherwise, it would switch to the Normal Mode. Worthwhile noticing, the signal LE(CA1) between the third and the fifth rising edges of CLK can not latch any data. Its level is just used for determining which mode to switch. However, the short pulse of \overline{OE} (CA2) can still enable the output ports. During mode switching, the serial data can still be transferred through SDI pin and shifted out from SDO pin.

Note:

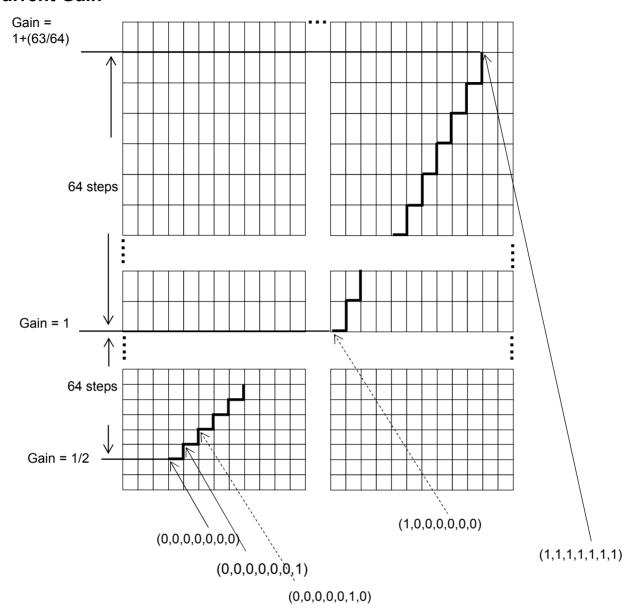
- 1. The signals for mode switching could be used for making sure under which mode MBI5028 is working.
- 2. The aforementioned "1" and "0" are sampled at the rising edge of CLK. The "X" means its level would not affect the result of mode switching.

Writing Configuration Code



After entering the Current Adjust mode, the system controller sends a 7-bit Current Adjust code to 16-bit Shift Register through MBI5028 SDI pin. Then sending LE(CA1) active pulse will transfer the contents in the Shift Register to a 16-bit Configuration Latch rather than the 16-bit Output Latch in a Normal mode. The 7-bit Current Adjust code in the Configuration Latch will directly affect the voltage at R-EXT terminal and output current lout by the gain, G. The output current resulted by the gain values will be then defined as: (0.63Volt x G / Rext) x 15. The gain will always be effective until power off or the Configuration Latch is re-written.

Current Gain



16-Bit Configuration Code

	Bit 0	Bit 1	Bit 2	Bit 3	Bit 4	Bit 5	Bit 6	Bit 7	Bit 8	Bit 9	Bit 10	Bit 11	Bit 12	Bit 13	Bit 14	Bit 15
Meaning	-	HC	CC0	CC1	CC2	CC3	CC4	CC5	ı	-	-	1	1	-	-	-
Default Value	-	1	1	1	1	1	1	1	ı	-	-	ı	ı	-	-	-

7-bit Current Adjust Code

Note: "-" means "reserved and not used now"

The relationship between the Current Adjust Code HC, CC [0:5] and current gain G is shown below: $G = (1 + HC) \times (1 + D/64)/2$

where HC is 1 or 0 (HC=0: Low current band; HC=1: High current band) and

D = CC0 x 2^5 + CC1 x 2^4 + CC2 x 2^3 + CC3 x 2^2 + CC4 x 2^1 + CC5 x 2^0 ;

So, the Current Adjust Code is a floating number with one bit exponent HC and 6-bit mantissa.

MBI5028 16-bit Constant Current LED Sink Driver with Gain Control

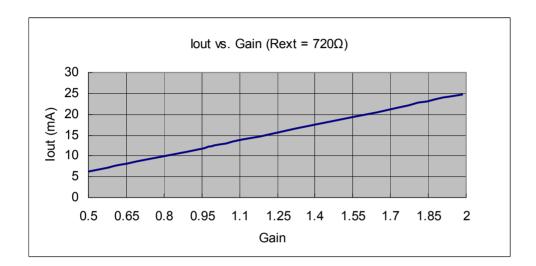
For example,

when the Current Adjust Code is (1,1,1,1,1,1,1)Gain, G = (1+1) x (1+63/64)/2 = 1.984

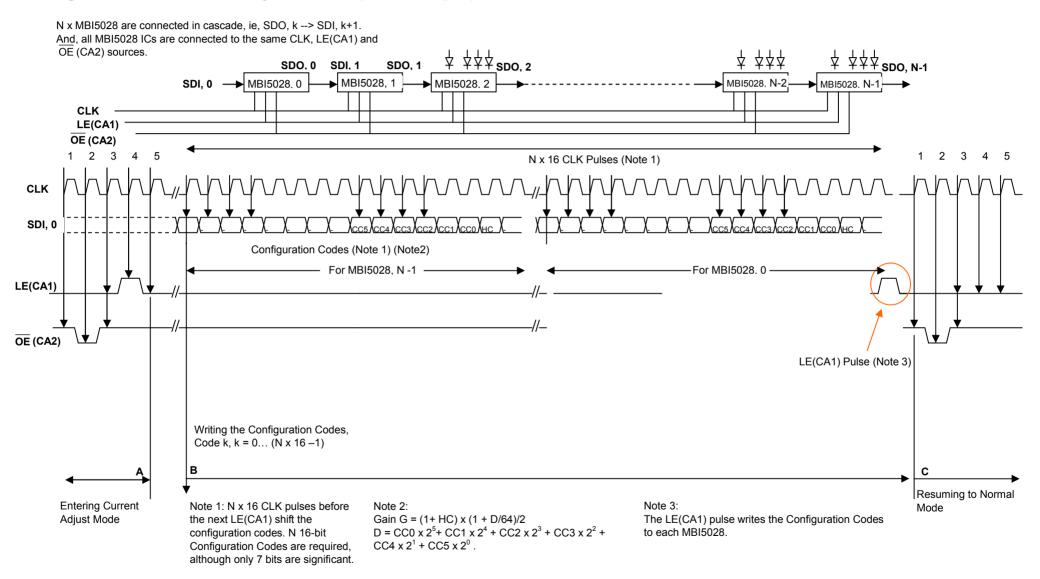
when the Current Adjust Code is (1,0,0,0,0,0,0,0)Gain, G = $(1+1) \times (1+0/64)/2 = 1$

when the Current Adjust Code is (0,0,0,0,0,0,0,0)Gain, G = $(1+0) \times (1+0/64)/2 = 0.5$

After power on, the default value of Current Adjust Code is (1,1,1,1,1,1). Thus, G is 1.984. Typically, the output current resulted by the digital current gain, G, is shown as the figure below.



Timing Chart for Current Adjust Mode (An Example)

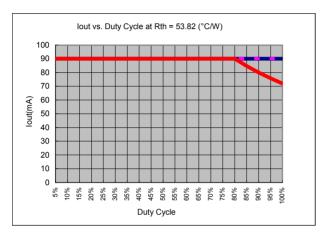


- 18 -

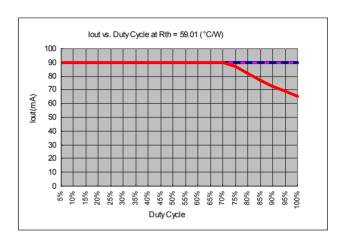
Package Power Dissipation (P_D)

The maximum allowable package power dissipation is determined as $P_D(max) = (Tj - Ta) / R_{th(j-a)}$. When 16 output channels are turned on simultaneously, the actual package power dissipation is $P_D(act) = (I_{DD} \times V_{DD}) + (I_{OUT} \times Duty \times V_{DS} \times 16)$. Therefore, to keep $P_D(act) \le P_D(max)$, the allowable maximum output current as a function of duty cycle is:

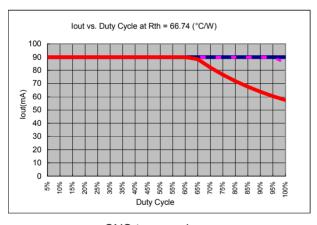
 $I_{OUT} = \{ [(Tj - Ta) / R_{th(j-a)}] - (I_{DD} x V_{DD}) \} / V_{DS} / Duty / 16,$ where Tj = 150°C.



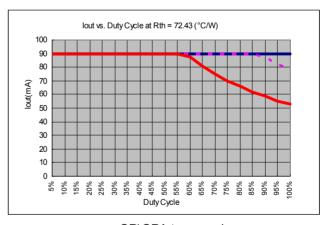
CN type package



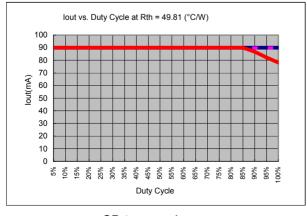
CF type package



CNS type package



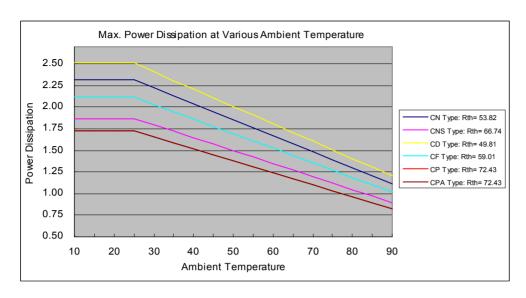
CP\CPA type package



CD type package

Condition: I _{out} = 90mA · V _{DS} = 1.0V · 16 output						
	channels activ	⁄e				
Device Type	$R_{th(j-a)}(^{\circ}C/W)$	Note				
CN	53.82					
CNS	66.74	——— Ta = 25°C				
CD	49.81	Ta = 55°C				
CF	59.01	Ta = 85°C				
CP\CPA	72.43					

The maximum power dissipation, $P_D(max) = (Tj - Ta) / R_{th(j-a)}$, decreases as the ambient temperature increases.

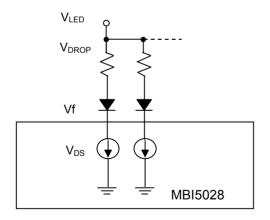


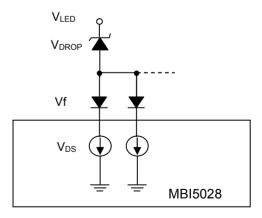
Load Supply Voltage (V_{LED})

MBI5028 are designed to operate with V_{DS} ranging from 0.4V to 1.0V considering the package power dissipating limits. V_{DS} may be higher enough to make $P_{D(act)} > P_{D(max)}$ when $V_{LED} = 5V$ and $V_{DS} = V_{LED} - Vf$, in which V_{LED} is the load supply voltage. In this case, it is recommended to use the lowest possible supply voltage or to set an external voltage reducer (V_{DROP}).

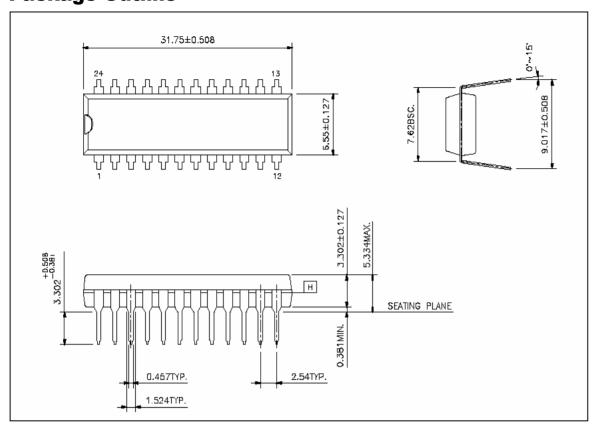
A voltage reducer lets $V_{DS} = (V_{LED} - Vf) - V_{DROP}$.

Resisters, or Zener diode can be used in the applications as the following figures.

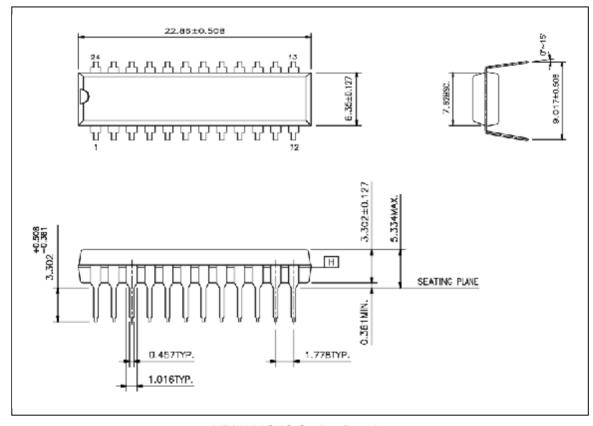




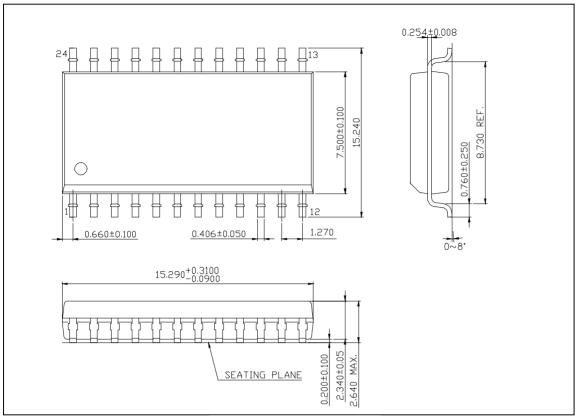
Package Outline



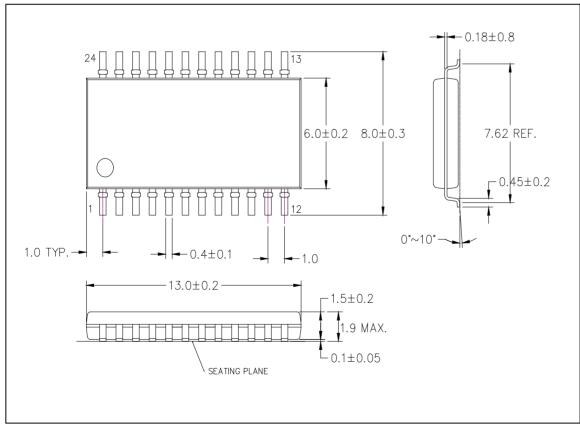
MBI5028CN Outline Drawing



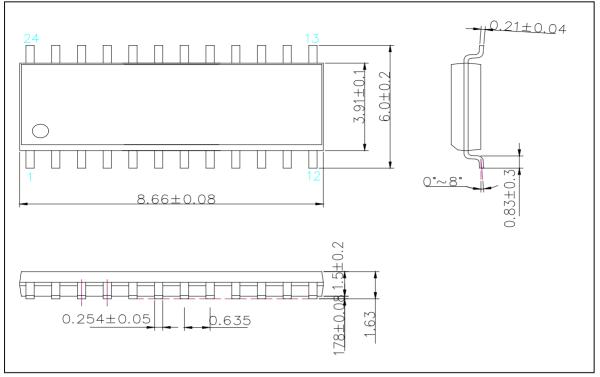
MBI5028CNS Outline Drawing



MBI5028CD Outline Drawing



MBI5028CF Outline Drawing



MBI5028CP\CPA Outline Drawing

MBI5028 Package Information

Device Type	Package Type	Weight(g)
CN	P-DIP24-300-2.54	1.628
CNS	SP-DIP24-300-1.78	1.11
CD	SOP24-300-1.27	0.617
CF	SOP24-300-1.00	0.28
CP\CPA	SSOP24-150-0.64	0.11

Note: The unit for the outline drawing is mm.